

MOSFET

OptiMOS™ 6 Power-Transistor, 150 V

Features

- N-channel, normal level
- Very low on-resistance R_{DS(on)}
- Superior thermal resistance
- 100% avalanche tested
- Pb-free lead plating; RoHS compliant
- Halogen-free according to IEC61249-2-21

Product validation

Type / Ordering code

IPP038N15NM6

Fully qualified according to JEDEC for Industrial Applications

Table 1 Key performance parameters

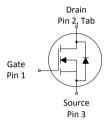
Parameter	Value	Unit
$V_{ extsf{DS}}$	150	V
$R_{\mathrm{DS(on),max}}$	3.8	mΩ
I_{D}	178	А
$Q_{ m oss}$	205	nC
Q_{G}	69	nC
Qrr (500A/μs)	166	nC

Package

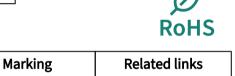
PG-TO220-3











038N15N6

Public

OptiMOS™ 6 Power-Transistor, 150 V IPP038N15NM6



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OptiMOS™ 6 Power-Transistor, 150 V IPP038N15NM6



1 Maximum ratings

at T_A =25 °C, unless otherwise specified

Table 2 Maximum ratings

Darameter	Symbol	Values			l lnit	Note / Test condition	
Parameter	Symbol	Min.	Тур.	Max.	Oilit	Note / Test condition	
				178		$V_{\rm GS}$ =10 V, $T_{\rm C}$ =25 °C	
Continuous drain current 1)	,		-	133	A	$V_{\rm GS} = 10 \text{V}, T_{\rm C} = 100 ^{\circ}\text{C}$	
Continuous drain current -/	l¹ _D	-		122	^	V _{GS} =8 V, T _C =100 °C	
				21		$V_{\rm GS}$ =10 V, $T_{\rm A}$ =25 °C, $R_{\rm thJA}$ =40 °C/W ²⁾	
Pulsed drain current ³⁾	$I_{\rm D,pulse}$	-	-	712	А	<i>T</i> _C =25 °C	
Avalanche current, single pulse ⁴⁾	I _{AS}	-	-	76	А		
Avalanche energy, single pulse	E_{AS}	-	-	503	mJ	$I_{\rm D}$ =51 A, $R_{\rm GS}$ =25 Ω	
Gate source voltage	V_{GS}	-20	-	20	V	-	
Power dissipation	P_{tot}			294	w	<i>T</i> _c =25 °C	
		-	_	3.8	VV	$T_{\rm C}$ =25 °C $T_{\rm A}$ =25 °C, $R_{\rm thJA}$ =40 °C/W ²⁾	
Operating and storage temperature	$T_{\rm j}, T_{\rm stg}$	-55	-	175	°C	-	

¹⁾ Rating refers to the product only with datasheet specified absolute maximum values, maintaining case temperature as specified. For other case temperatures please refer to Diagram 2. De-rating will be required based on the actual environmental conditions.

2 Thermal characteristics

Table 3 Thermal characteristics

Parameter	Symbol	Values			Unit	Note / Test condition
	Syllibol	Min.	Тур.	Max.	Oilit	Note / Test condition
Thermal resistance, junction - case	R_{thJC}	-	-	0.51	°C/W	
Thermal resistance, junction - ambient, 6 cm² cooling area ⁵⁾	R_{thJA}	-	-	40	°C/W	-
Thermal resistance, junction - ambient, minimal footprint	R_{thJA}	-	-	62	°C/W	

Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm 2 (one layer, 70 μ m thick) copper area for drain connection. PCB is vertical in still air.

²⁾ Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm² (one layer, 70 μm thick) copper area for drain connection. PCB is vertical in still air.

³⁾ See Diagram 3 for more detailed information

⁴⁾ See Diagram 13 for more detailed information

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3 Electrical characteristics

at $T_{\rm j}$ =25 °C, unless otherwise specified

Table 4 Static characteristics

Parameter	Symbol	Values			l lmit	Note / Test condition
raiailletei	Syllibot	Min.	Тур.	Max.		Note / Test condition
Drain-source breakdown voltage	V _{(BR)DSS}	150	-	-	V	$V_{\rm GS}$ =0 V, $I_{\rm D}$ =1 mA
Gate threshold voltage	$V_{\rm GS(th)}$	3.0	3.5	4.0	V	$V_{\rm DS} = V_{\rm GS}, I_{\rm D} = 179 \mu \text{A}$
Zero gate voltage drain current	I _{DSS}	-	0.1 10	1 100	μΑ	$V_{\rm DS}$ =120 V, $V_{\rm GS}$ =0 V, $T_{\rm j}$ =25 °C $V_{\rm DS}$ =120 V, $V_{\rm GS}$ =0 V, $T_{\rm j}$ =125 °C
Gate-source leakage current	I _{GSS}	-	10	100	nA	$V_{\rm GS}$ =20 V, $V_{\rm DS}$ =0 V
Drain-source on-state resistance	$R_{ m DS(on)}$	-	3.3 3.6 4.0	3.6 3.8 4.5	mΩ	V_{GS} =15 V, I_{D} =76 A V_{GS} =10 V, I_{D} =76 A V_{GS} =8 V, I_{D} =38 A
Gate resistance	R_{G}	-	0.98	1.47	Ω	-
Transconductance	g_{fs}	65	130	-	S	$ V_{\rm DS} \ge 2 I_{\rm D} R_{\rm DS(on)max}, I_{\rm D}=76 \text{ A}$

Table 5 Dynamic characteristics

Parameter	Symbol	Values			Linit	Note / Test condition
	Syllibot	Min.	Тур.	Max.	Oilit	Note / Test condition
Input capacitance ⁶⁾	C _{iss}	-	4900	6400	pF	
Output capacitance ⁶⁾	Coss	-	1500	2000	pF	$V_{\rm GS}$ =0 V, $V_{\rm DS}$ =75 V, f =1 MHz
Reverse transfer capacitance ⁶⁾	C _{rss}	-	19	33	pF	
Turn-on delay time	t _{d(on)}	-	18	_	ns	$V_{\rm DD}$ =75 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =38 A, $R_{\rm G,ext}$ =1.6 Ω
Rise time	t _r	-	17	-	ns	
Turn-off delay time	$t_{\sf d(off)}$	-	27	-	ns	
Fall time	t_{f}	-	15	-	ns	

 $^{^{6)}\;\;}$ Defined by design. Not subject to production test.

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Table 6 Gate charge characteristics 7)

Parameter	Symbol	Values			Unit	Note / Test condition
	Syllibol	Min.	Тур.	Max.		Note / Test condition
Gate to source charge ⁸⁾	Q_{gs}	-	27	36	nC	
Gate charge at threshold	$Q_{\mathrm{g(th)}}$	-	17.3	-	nC	$V_{\rm DD}$ =75 V, $I_{\rm D}$ =38 A, $V_{\rm GS}$ =0 to 10 V
Gate to drain charge ⁸⁾	Q_{gd}	-	15.7	24	nC	
Switching charge	$Q_{\rm sw}$	-	25	-	nC	
Gate charge total ⁸⁾	$Q_{ m g}$	-	69	86	nC	
Gate plateau voltage	$V_{ m plateau}$	-	5.4	-	V	
Gate charge total, sync. FET	$Q_{\rm g(sync)}$	-	58	-	nC	V _{DS} =0.1 V, V _{GS} =0 to 10 V
Output charge ⁸⁾	Q _{oss}	-	205	273	nC	V _{DS} =75 V, V _{GS} =0 V

⁷⁾ See "Gate charge waveforms" for parameter definition

Table 7 Reverse diode

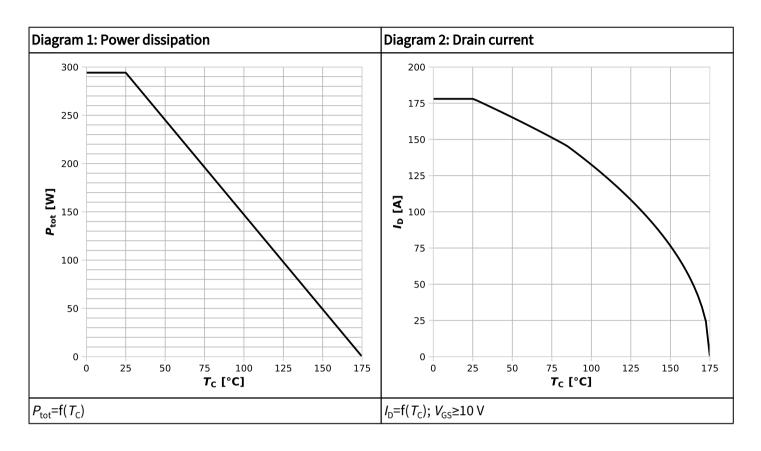
Parameter	Symbol	Values			Linit	Note / Test condition
	Syllibol	Min.	Тур.	Max.	Oilit	Note / Test condition
Diode continuous forward current	I_{S}	-	-	173	А	<i>T_c</i> =25 °C
Diode pulse current	I _{S,pulse}	-	-	712	Α	1 _C -25 C
Diode forward voltage	$V_{\rm SD}$	-	0.89	1.0	V	$V_{\rm GS}$ =0 V, $I_{\rm F}$ =76 A, $T_{\rm j}$ =25 °C
Reverse recovery time ⁹⁾	t_{rr}	-	39	78	ns	V _R =75 V, I _F =38 A, d <i>i</i> _F /d <i>t</i> =500 A/μs
Reverse recovery charge ⁹⁾	$Q_{\rm rr}$	-	166	332	nC	
Reverse recovery time ⁹⁾	t _{rr}	-	33	66	ns	$V_{\rm R}$ =75 V, $I_{\rm F}$ =38 A, d $i_{\rm F}$ /d t =1000 A/ μ s
Reverse recovery charge ⁹⁾	$Q_{\rm rr}$	-	272	544	nC	

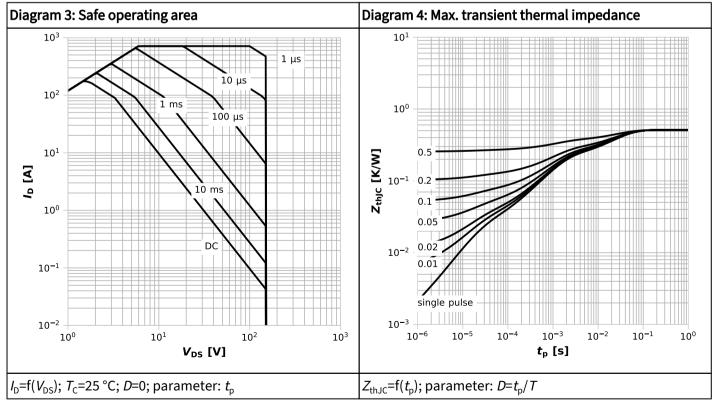
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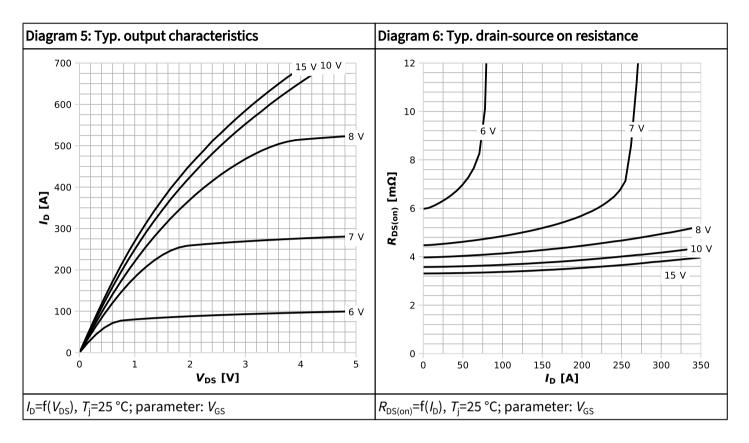


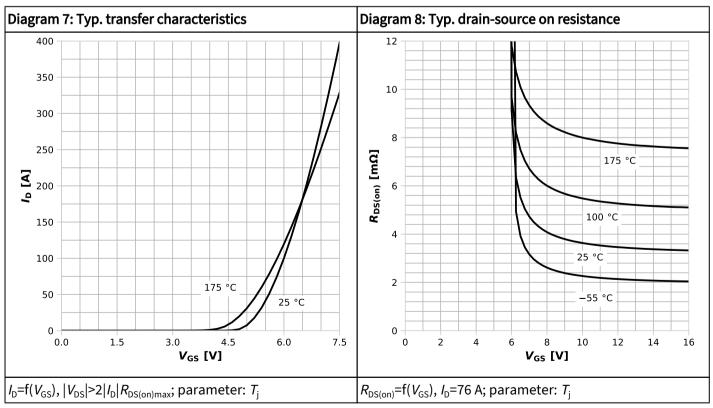
4 Electrical characteristics diagrams



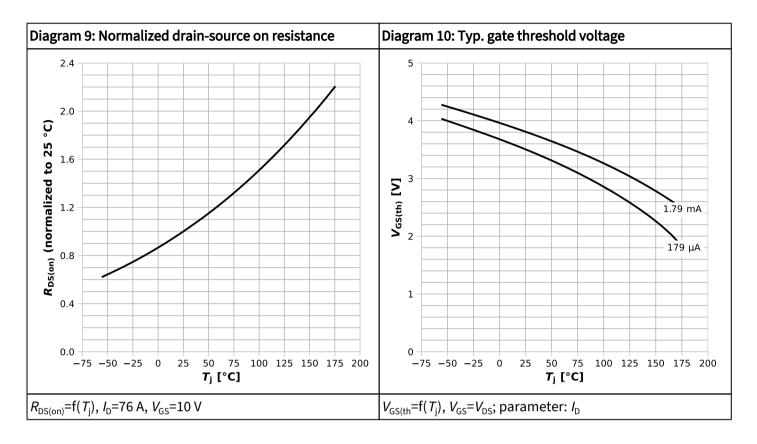


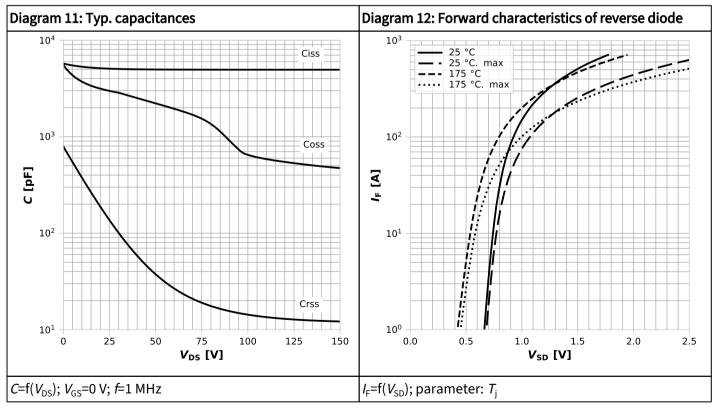




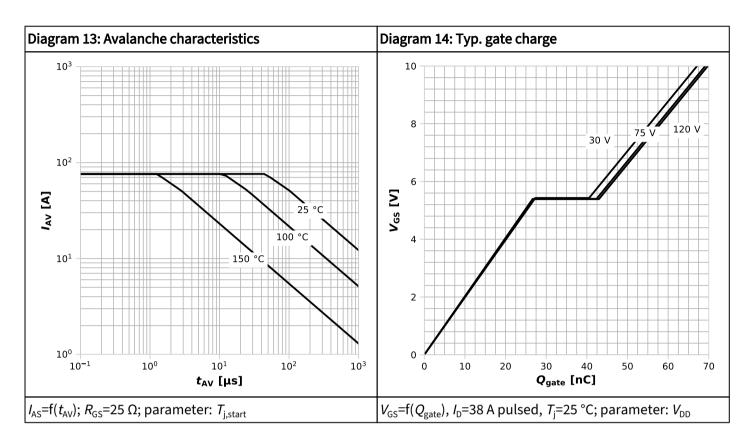


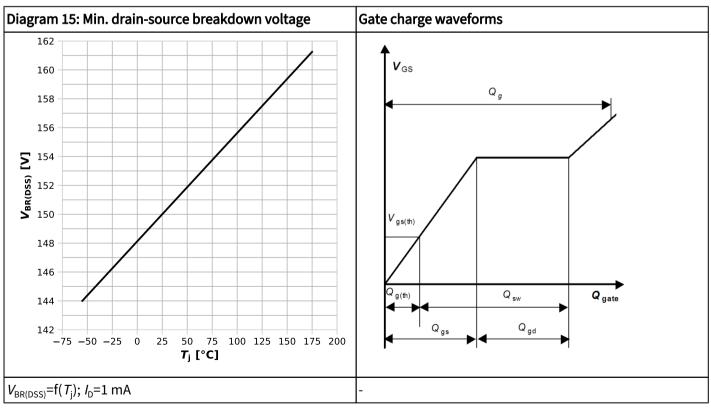














5 Package outlines

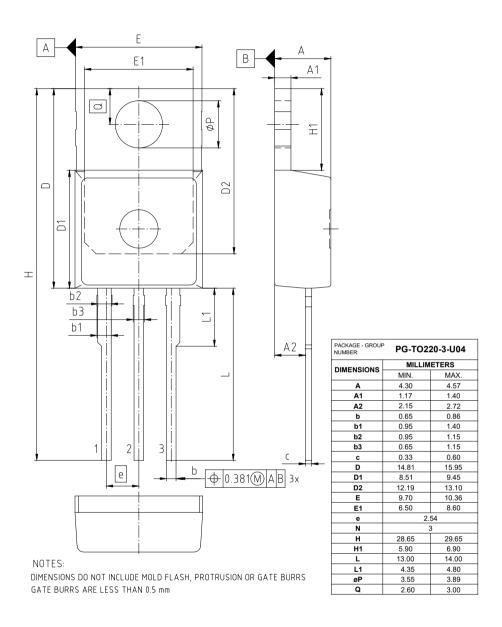


Figure 1 Outline PG-TO220-3, dimensions in mm

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Revision history

IPP038N15NM6

Revision 2024-12-09, Rev. 1.0

Previous revisions

Revision	Date	Subjects (major changes since last revision)
1.0	2024-12-09	Release of final datasheet

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